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NSVF6003SB6

RF Transistor 12 V, 150 mA, $f_T = 7$ GHz, NPN Single



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This RF transistor is designed for low noise amplifier applications. CPH package is suitable for use under high temperature environment because it has superior heat radiation characteristics. This RF transistor is AEC-Q101 qualified and PPAP capable for automotive applications.

Features

- High Gain ($f_T = 7$ GHz typ)
- High Current ($I_C = 150$ mA)
- Miniature and Thin 6 pin Package
- Large Collector Dissipation (800 mW)
- AEC-Q101 qualified and PPAP capable
- Pb-Free, Halogen Free and RoHS compliance

Typical Applications

- Low Noise Amplifier for FM Radio
- Low Noise Amplifier for TV

SPECIFICATIONS

ABSOLUTE MAXIMUM RATING at $T_a = 25^\circ\text{C}$ (Note 1)

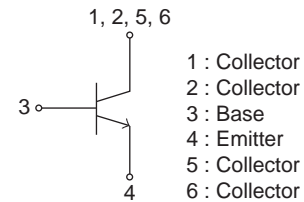
Parameter	Symbol	Value	Unit
Collector to Base Voltage	V_{CB0}	20	V
Collector to Emitter Voltage	V_{CEO}	12	V
Emitter to Base Voltage	V_{EBO}	2	V
Collector Current	I_C	150	mA
Collector Dissipation (Note 2)	P_C	800	mW
Operating Junction and Storage Temperature	T_j, T_{stg}	-55 to +150	$^\circ\text{C}$

Note 1 : Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

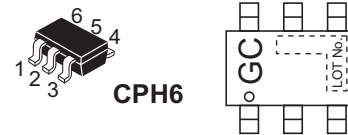
Note 2 : Surface mounted on ceramic substrate ($250\text{ mm}^2 \times 0.8\text{ mm}$).

12 V, 150 mA
 $f_T = 7$ GHz typ.
RF Transistor

ELECTRICAL CONNECTION NPN



MARKING



ORDERING INFORMATION

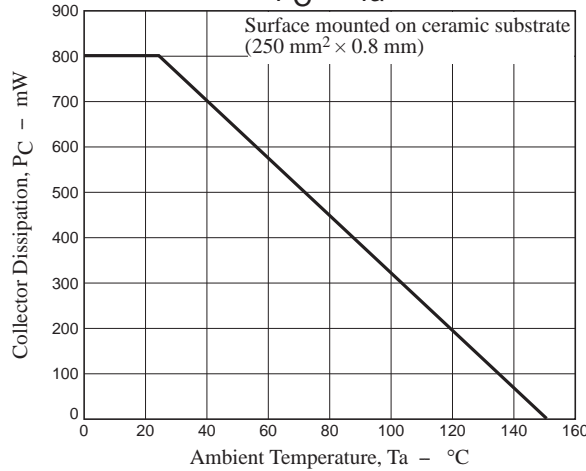
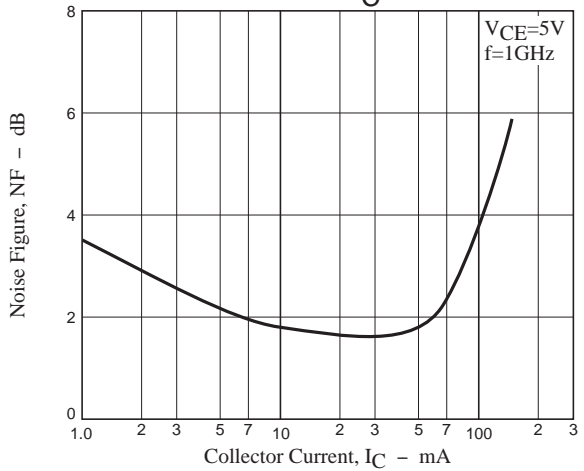
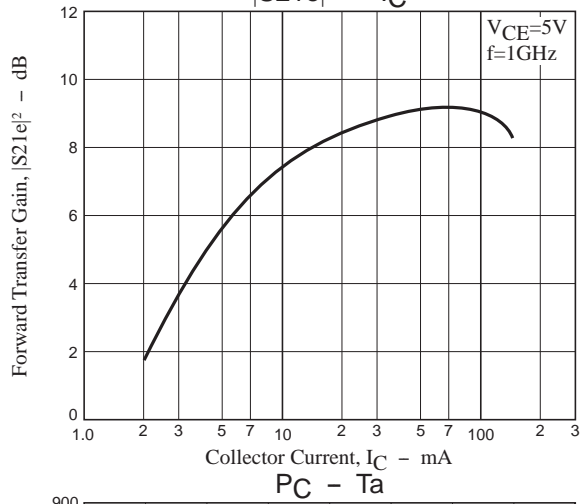
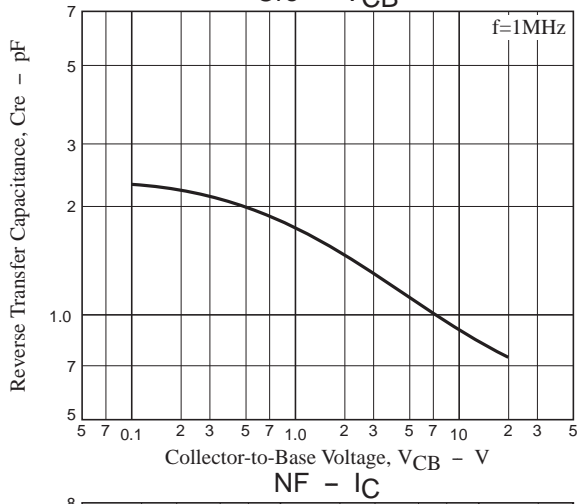
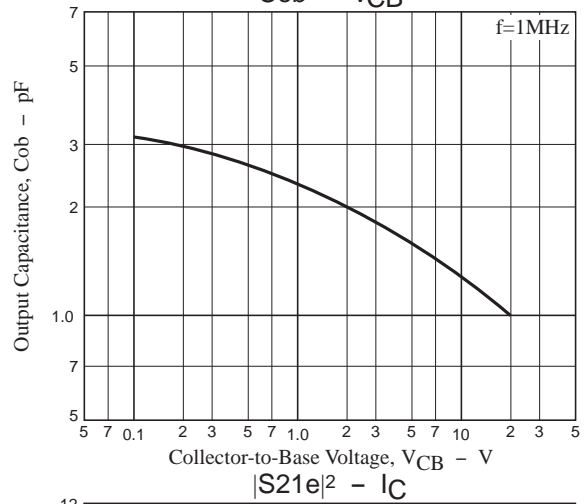
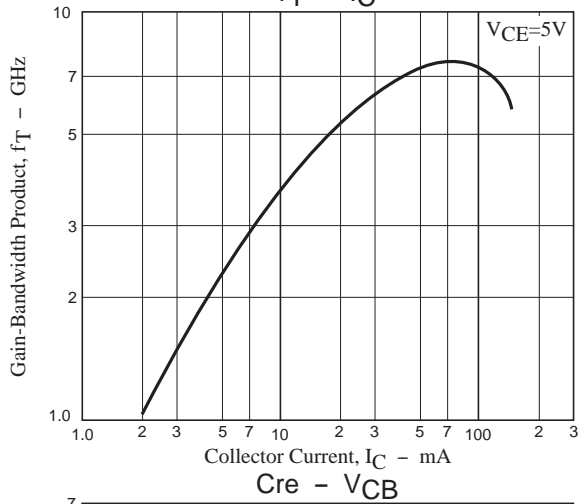
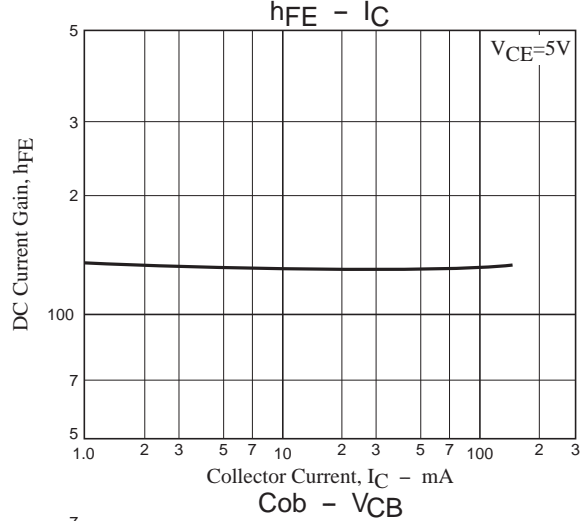
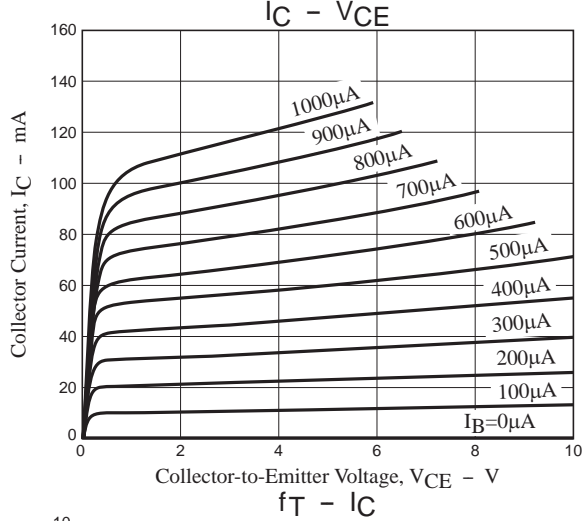
See detailed ordering and shipping information on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 3)

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
Collector Cutoff Current	ICBO	V _{CB} = 10 V, I _E = 0 A			1.0	μA
Emitter Cutoff Current	IEBO	VEB = 1 V, I _C = 0 A			10	μA
DC Current Gain	hFE	V _{CE} = 5 V, I _C = 50 mA	100		180	
Gain-Bandwidth Product	f _T			7		GHz
Output Capacitance	Cob	V _{CB} = 10 V, f = 1 MHz		1.3	2.0	pF
Reverse Transfer Capacitance	Cre			0.9		pF
Forward Transfer Gain	S _{21e} ²	V _{CE} = 5 V, I _C = 50 mA, f = 1 GHz		9.0		dB
Noise Figure	NF	V _{CE} = 5 V, I _C = 5.0 mA, f = 1 GHz		1.8	3.0	dB

Note 3 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Note 4 : Pay attention to handling since it is liable to be affected by static electricity due to the high-frequency process adopted.



S Parameters (Common emitter)

$V_{CE} = 5\text{ V}$, $I_C = 20\text{ mA}$, $Z_O = 50\ \Omega$

Freq(MHz)	S ₁₁	∠S ₁₁	S ₂₁	∠S ₂₁	S ₁₂	∠S ₁₂	S ₂₂	∠S ₂₂
100	0.550	254.1	21.532	119.9	0.036	54.6	0.527	-62.8
200	0.492	218.1	12.273	103.0	0.050	56.5	0.332	-80.3
300	0.477	201.9	8.448	95.3	0.063	61.7	0.267	-88.3
400	0.470	192.4	6.427	90.4	0.078	65.3	0.242	268.1
500	0.518	181.0	5.015	86.8	0.089	68.2	0.217	245.3
600	0.513	175.8	4.221	83.9	0.104	70.2	0.216	245.8
700	0.510	171.5	3.658	81.3	0.120	71.7	0.214	247.2
800	0.508	167.6	3.234	78.9	0.135	72.7	0.220	249.3
900	0.503	163.7	2.900	76.7	0.150	73.2	0.225	251.3
1000	0.497	160.1	2.636	74.4	0.166	73.7	0.231	254.6
1100	0.493	156.8	2.419	72.5	0.181	73.9	0.239	256.3
1200	0.489	153.4	2.243	70.5	0.196	74.1	0.247	258.8

$V_{CE} = 5\text{ V}$, $I_C = 50\text{ mA}$, $Z_O = 50\ \Omega$

Freq(MHz)	S ₁₁	∠S ₁₁	S ₂₁	∠S ₂₁	S ₁₂	∠S ₁₂	S ₂₂	∠S ₂₂
100	0.465	231.1	25.203	111.9	0.029	59.2	0.413	-79.9
200	0.449	203.4	13.519	98.7	0.045	65.7	0.269	259.6
300	0.445	191.6	9.177	92.7	0.061	70.4	0.230	250.7
400	0.443	184.2	6.947	88.8	0.078	72.8	0.218	247.3
500	0.502	175.0	5.407	86.1	0.092	74.7	0.231	224.3
600	0.497	170.3	4.550	83.7	0.110	75.6	0.229	225.5
700	0.494	166.4	3.944	81.5	0.127	76.2	0.225	227.1
800	0.490	162.8	3.483	79.4	0.144	76.4	0.228	229.9
900	0.485	159.1	3.127	77.4	0.161	76.2	0.230	232.4
1000	0.478	155.5	2.845	75.5	0.178	76.1	0.230	236.1
1100	0.473	152.3	2.608	73.6	0.195	75.9	0.236	238.6
1200	0.468	149.0	2.423	71.9	0.211	75.5	0.239	242.0

$V_{CE} = 5\text{ V}$, $I_C = 100\text{ mA}$, $Z_O = 50\ \Omega$

Freq(MHz)	S ₁₁	∠S ₁₁	S ₂₁	∠S ₂₁	S ₁₂	∠S ₁₂	S ₂₂	∠S ₂₂
100	0.451	219.5	25.808	108.5	0.026	62.4	0.359	-86.7
200	0.448	196.7	13.593	96.8	0.043	69.8	0.240	253.1
300	0.448	187.0	9.193	91.4	0.060	73.8	0.212	244.9
400	0.446	180.7	6.953	87.8	0.078	75.5	0.205	242.3
500	0.508	172.6	5.408	85.5	0.093	76.9	0.228	219.9
600	0.503	168.3	4.550	83.1	0.110	77.5	0.226	221.5
700	0.500	164.6	3.944	81.0	0.128	77.8	0.223	223.4
800	0.497	161.2	3.480	79.0	0.145	77.8	0.226	226.5
900	0.490	157.6	3.132	77.0	0.163	77.4	0.228	229.1
1000	0.484	154.2	2.842	75.0	0.180	77.1	0.227	233.1
1100	0.479	151.0	2.614	73.3	0.197	76.7	0.232	235.8
1200	0.473	147.8	2.423	71.6	0.214	76.3	0.236	239.3

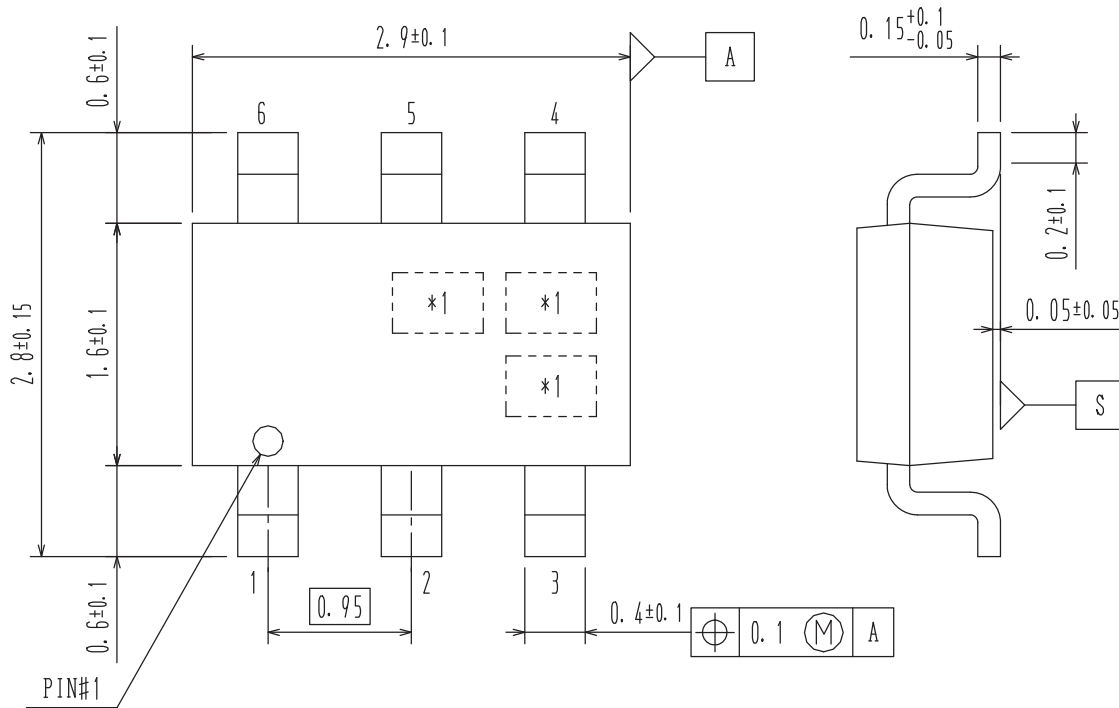
PACKAGE DIMENSIONS

unit : mm

CPH6

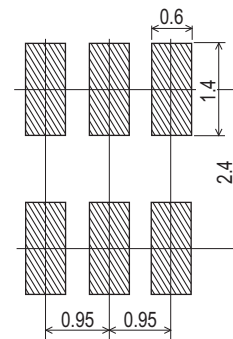
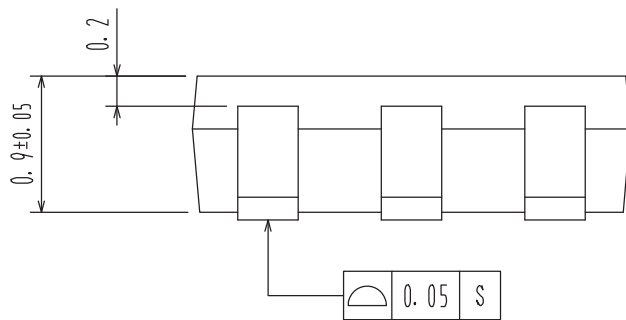
CASE 318BD

ISSUE O



RECOMMENDED SOLDERING FOOTPRINT

*1: Lot indication



- 1 : Collector
- 2 : Collector
- 3 : Base
- 4 : Emitter
- 5 : Collector
- 6 : Collector

ORDERING INFORMATION

Device	Marking	Package	Shipping (Qty / Packing)
NSVF6003SB6T1G	GC	CPH6 (Pb-Free / Halogen Free)	3,000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

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